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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/784,888	02/24/2004	Akira Suzuki	492322016900	9967
25227 7590 08/07/2007 MORRISON & FOERSTER LLP 1650 TYSONS BOULEVARD SUITE 400 MCLEAN, VA 22102			EXAMINER	
			SMITH, BRADLEY	
			ART UNIT	PAPER NUMBER
MCLEAN, VA			2891	
			MAIL DATE	DELIVERY MODE
•			08/07/2007	PAPER

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

	Application No.	Applicant(s)			
	10/784,888	SUZUKI ET AL.			
Office Action Summary	Examiner	Art Unit			
	Bradley K. Smith	2891			
The MAILING DATE of this communication app Period for Reply	ears on the cover sheet with the c	orrespondence address			
A SHORTENED STATUTORY PERIOD FOR REPLY WHICHEVER IS LONGER, FROM THE MAILING DY. - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period volume to reply within the set or extended period for reply will, by statute Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be tim vill apply and will expire SIX (6) MONTHS from cause the application to become ABANDONE	I. sely filed the mailing date of this communication. D (35 U.S.C. § 133).			
Status .					
1) Responsive to communication(s) filed on 20 Ju	<u>ıly 2007</u> .				
·	-				
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.					
closed in accordance with the practice under E	:x parte Quayle, 1935 С.D. 11, 48	00.0.210.			
Disposition of Claims					
 4) Claim(s) 1-3.5-18 is/are pending in the applica 4a) Of the above claim(s) 1,2,5,8,9 and 11-16 is 5) Claim(s) 17 is/are allowed. 6) Claim(s) 3,10 and 18 is/are rejected. 7) Claim(s) 6 and 7 is/are objected to. 8) Claim(s) are subject to restriction and/o 	s/are withdrawn from consideration	on.			
Application Papers					
9) The specification is objected to by the Examine 10) The drawing(s) filed on is/are: a) accomplicant may not request that any objection to the Replacement drawing sheet(s) including the correct 11) The oath or declaration is objected to by the Examine	epted or b) objected to by the l drawing(s) be held in abeyance. Sec ion is required if the drawing(s) is ob	e 37 CFR 1.85(a). jected to. See 37 CFR 1.121(d).			
Priority under 35 U.S.C. § 119	•				
12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of: 1. Certified copies of the priority document 2. Certified copies of the priority document 3. Copies of the certified copies of the priority document application from the International Bureau * See the attached detailed Office action for a list	s have been received. s have been received in Applicati rity documents have been receive u (PCT Rule 17.2(a)).	on No ed in this National Stage			
Attachment(s) 1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO/SB/08) Paper No(s)/Mail Date	4) Interview Summary Paper No(s)/Mail Di 5) Notice of Informal F 6) Other: search notes	ate Patent Application			

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DETAILED ACTION

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 3, 10 and 18 are rejected under 35 U.S.C. 103(a) as being unpatentable over Young et al (US 5,994,204) in view of Moon et al. (US 5,719,085). Regarding claims 1 and 18, Young disclose bonding a supporting member (312) to a first surface of a semiconductor wafer (302) on which a semiconductor element is formed; forming a groove in the semiconductor wafer by a first etching of a second surface of the semiconductor wafer, the second surface being opposite to the first surface (see figure 3A-3E). Young et al. fails to disclose the rounding of a corner of groove by the second etching of the surface wherein the second etching comprises wet etching. However, Moon et al. disclose the formation of a round corner by a second etching wherein the second etching comprises wet etching (see figures 3d and 3e). With regards to claim 10 Moon et al disclose removing a foreign substance (silicon oxide) from the trench. Therefore it would have been obvious to one of ordinary skill in the art at the time the invention was made to combine the teachings of Young and Moon because the rounding of the corner would help to reduce leakage current (see Moon column 5 lines 17 and 18).

Allowable Subject Matter

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Claim 17 is allowed.

Claims 6 and 7 are objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.

The following is a statement of reasons for the indication of allowable subject matter: the prior art neither teaches nor suggests Wet etching comprises dropping an etching solution on the second surface in which the groove is formed and spinning the semiconductor wafer to spread the etching solution over the second surface (claims 6 and 7), forming second insulation on the rounded corners removing parts of the first and second insulation films at an etching step to expose at least part of the wiring (claim 17).

Response to Arguments

Applicant's arguments with respect to claims 3, 10, and 18 have been considered but are most in view of the new ground(s) of rejection.

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Bradley K. Smith whose telephone number is 571-272-1884. The examiner can normally be reached on 10-6.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Bill Baumeister can be reached on 571-272-1722. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000

Bradley (K Smith Primary Examiner Art Unit 2891
